

Electronic Patent Application Fee Transmittal

| | | | | |
|---------------------------------------------|------------------------------------------------------------|-----------------|---------------|-----------------------------|
| Application Number: | 10807527 | | | |
| Filing Date: | 24-Mar-2004 | | | |
| Title of Invention: | Land grid array packaged device and method of forming same | | | |
| First Named Inventor/Applicant Name: | Hei Ming Shiu | | | |
| Filer: | Charles Edward Bergere/Jeslyn Goh | | | |
| Attorney Docket Number: | SC13154HP | | | |
| Filed as Large Entity | | | | |
| Utility Filing Fees | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Filing a brief in support of an appeal | 1402 | 1 | 500 | 500 |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-------------------|----------|----------|--------|----------------------|
| Miscellaneous: | | | | |
| Total in USD (\$) | | | | 500 |